

IRGR3B60KD2PbF

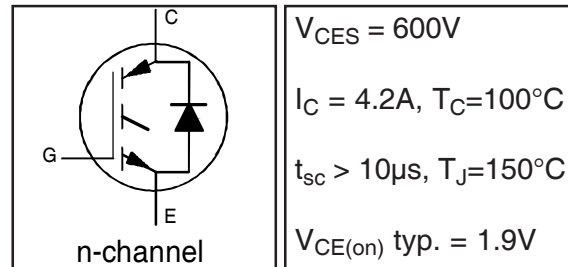
INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

Features

- Low VCE (on) Non Punch Through IGBT Technology.
- Low Diode VF.
- 10μs Short Circuit Capability.
- Square RBSOA.
- Ultrasoft Diode Reverse Recovery Characteristics.
- Positive VCE (on) Temperature Coefficient.
- Lead-Free

Benefits

- Benchmark Efficiency for Motor Control.
- Rugged Transient Performance.
- Low EMI.
- Excellent Current Sharing in Parallel Operation.



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	7.8	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	4.2	
I_{CM}	Pulse Collector Current (Ref.Fig.C.T.5)	15.6	
I_{LM}	Clamped Inductive Load current ①	15.6	
$I_F @ T_C = 25^\circ C$	Diode Continuous Forward Current	6.0	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	3.2	A
I_{FM}	Diode Maximum Forward Current	15.6	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	52	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	21	
T_J	Operating Junction and	-55 to +150	$^\circ C$
T_{STG}	Storage Temperature Range		
	Soldering Temperature Range, for 10 sec.	300 (0.063 in. (1.6mm) from case)	

Thermal / Mechanical Characteristics

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case- IGBT	—	—	2.4	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case- Diode	—	—	8.8	
$R_{\theta JA}$	Junction-to-Ambient, (PCB Mount) ②	—	—	50	
Wt	Weight	—	0.3	—	g

IRGR3B60KD2PbF

International
IR Rectifier

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Ref.Fig.
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{GE} = 0V, I_C = 500\mu A$	
$\Delta V_{(BR)CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	—	0.32	—	V/ $^\circ\text{C}$	$V_{GE} = 0V, I_C = 1mA (25^\circ\text{C}-150^\circ\text{C})$	
$V_{CE(on)}$	Collector-to-Emitter Voltage	—	1.9	2.4	V	$I_C = 3.0A, V_{GE} = 15V$	5,6,7
		—	2.2	2.6		$I_C = 3.0A, V_{GE} = 15V, T_J = 150^\circ\text{C}$	9,10,11
						$V_{CE} = V_{GE}, I_C = 250\mu A$	9,10,11
$V_{GE(th)}$	Gate Threshold Voltage	3.5	4.5	5.5	mV/ $^\circ\text{C}$	$V_{CE} = V_{GE}, I_C = 1mA (25^\circ\text{C}-150^\circ\text{C})$	12
$\Delta V_{GE(th)}/\Delta T_J$	Threshold Voltage temp. coefficient	—	-8.5	—			
gfe	Forward Transconductance	—	1.9	—	S	$V_{CE} = 50V, I_C = 3.0A, PW = 80\mu s$	
I_{CES}	Zero Gate Voltage Collector Current	—	1.0	150	μA	$V_{GE} = 0V, V_{CE} = 600V$	
		—	200	500		$V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$	
V_{FM}	Diode Forward Voltage Drop	—	1.5	1.8	V	$I_F = 3.0A, V_{GE} = 0V$	8
		—	1.5	1.8		$I_F = 3.0A, V_{GE} = 0V, T_J = 150^\circ\text{C}$	
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{GE} = \pm 20V, V_{CE} = 0V$	

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	Ref.Fig.
Q_g	Total Gate Charge (turn-on)	—	13	20	nC	$I_C = 3.0A$	23
Q_{ge}	Gate-to-Emitter Charge (turn-on)	—	1.5	2.3		$V_{CC} = 400V$	CT1
Q_{gc}	Gate-to-Collector Charge (turn-on)	—	6.6	9.9		$V_{GE} = 15V$	
E_{on}	Turn-On Switching Loss	—	62	75	μJ	$I_C = 3.0A, V_{CC} = 400V$	CT4
E_{off}	Turn-Off Switching Loss	—	39	50		$V_{GE} = 15V, R_G = 100\Omega, L = 2.5mH$	
E_{tot}	Total Switching Loss	—	100	120		$T_J = 25^\circ\text{C}$ ③	
$t_{d(on)}$	Turn-On delay time	—	18	22	ns	$I_C = 3.0A, V_{CC} = 400V$	CT4
t_r	Rise time	—	15	21		$V_{GE} = 15V, R_G = 100\Omega, L = 2.5mH$	
$t_{d(off)}$	Turn-Off delay time	—	110	120		$T_J = 25^\circ\text{C}$	
t_f	Fall time	—	68	80			
E_{on}	Turn-On Switching Loss	—	91	100	μJ	$I_C = 3.0A, V_{CC} = 400V$	CT4
E_{off}	Turn-Off Switching Loss	—	98	140		$V_{GE} = 15V, R_G = 100\Omega, L = 2.5mH$	13,15
E_{tot}	Total Switching Loss	—	190	230		$T_J = 150^\circ\text{C}$ ③	WF1,WF2
$t_{d(on)}$	Turn-On delay time	—	18	22	ns	$I_C = 3.0A, V_{CC} = 400V$	14,16
t_r	Rise time	—	17	22		$V_{GE} = 15V, R_G = 100\Omega, L = 2.5mH$	CT4
$t_{d(off)}$	Turn-Off delay time	—	120	140		$T_J = 150^\circ\text{C}$	WF1
t_f	Fall time	—	91	105			WF2
C_{ies}	Input Capacitance	—	190	—	pF	$V_{GE} = 0V$	22
C_{oes}	Output Capacitance	—	23	—		$V_{CC} = 30V$	
C_{res}	Reverse Transfer Capacitance	—	6.6	—		$f = 1.0MHz$	
RBSOA	Reverse Bias Safe Operating Area	FULL SQUARE				$T_J = 150^\circ\text{C}, I_C = 15.6A, V_p = 600V$ $V_{CC}=500V, V_{GE}=+15V \text{ to } 0V, R_G = 100\Omega$	4 CT2
SCSOA	Short Circuit Safe Operating Area	10	—	—	μs	$T_J = 150^\circ\text{C}, V_p = 600V, R_G = 100\Omega$ $V_{CC}=360V, V_{GE} = +15V \text{ to } 0V$	CT3 WF4
Erec	Reverse Recovery Energy of the Diode	—	38	44	μJ	$T_J = 150^\circ\text{C}$	17,18,19
t_{rr}	Diode Reverse Recovery Time	—	77	84	ns	$V_{CC} = 400V, I_F = 3.0A, L = 2.5mH$	20,21
I_{rr}	Diode Peak Reverse Recovery Current	—	4.8	5.3	A	$V_{GE} = 15V, R_G = 100\Omega$	CT4,WF3

① $V_{CC} = 80\% (V_{CES}), V_{GE} = 15V, L = 100\mu H, R_G = 100\Omega$.

③ Energy losses include "tail" and diode reverse recovery.

② When mounted on 1" square PCB (FR-4 or G-10 Material) . For recommended footprint and soldering techniques refer to application note #AN-994.

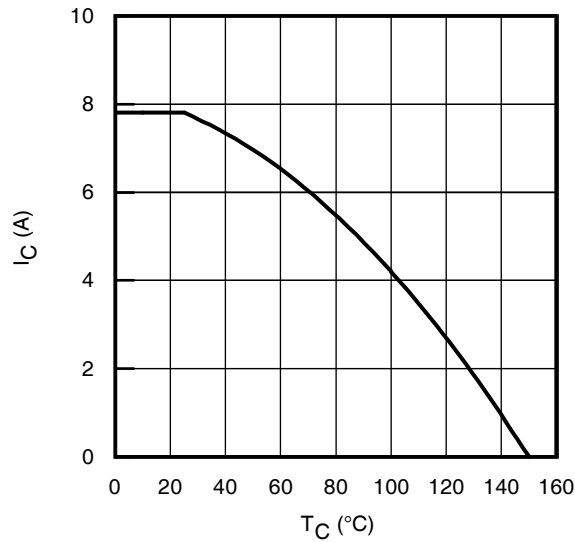


Fig. 1 - Maximum DC Collector Current vs. Case Temperature

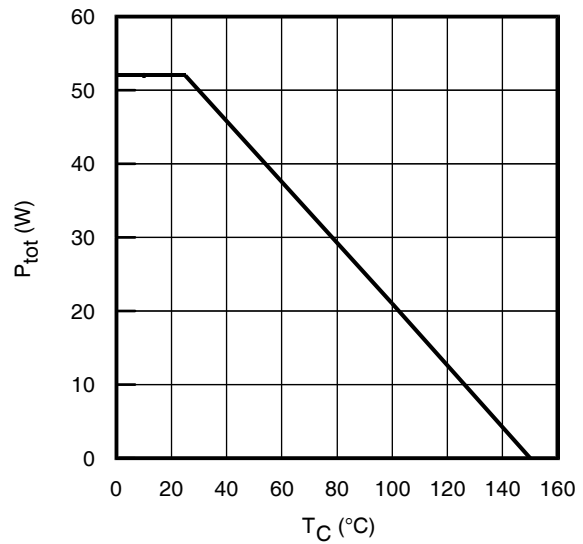


Fig. 2 - Power Dissipation vs. Case Temperature

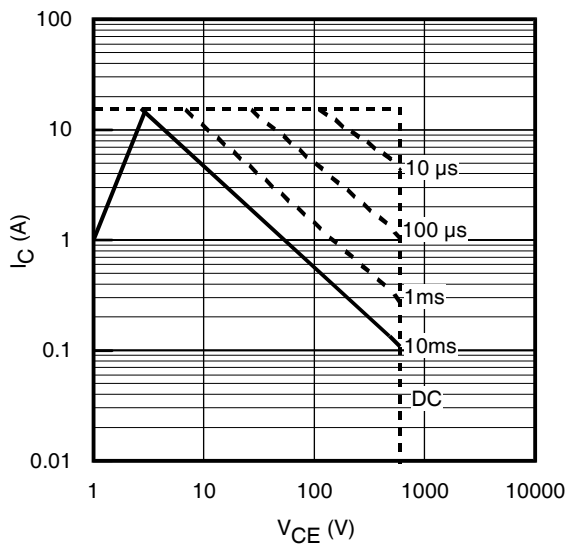


Fig. 3 - Forward SOA
 $T_C = 25^{\circ}\text{C}$; $T_J \leq 150^{\circ}\text{C}$

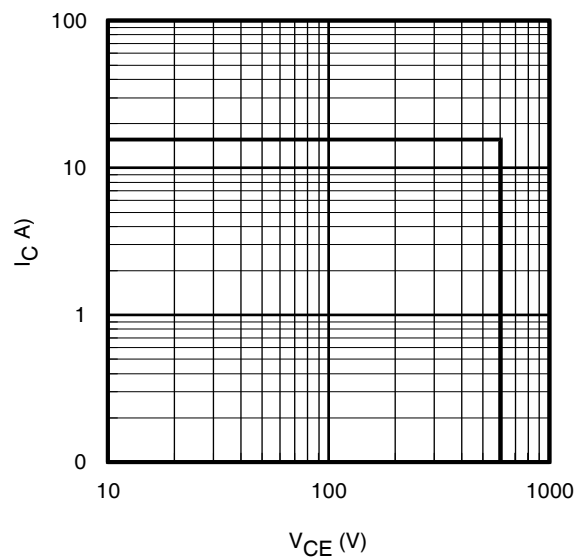


Fig. 4 - Reverse Bias SOA
 $T_J = 150^{\circ}\text{C}$; $V_{GE} = 15\text{V}$

IRGR3B60KD2PbF

International
IR Rectifier

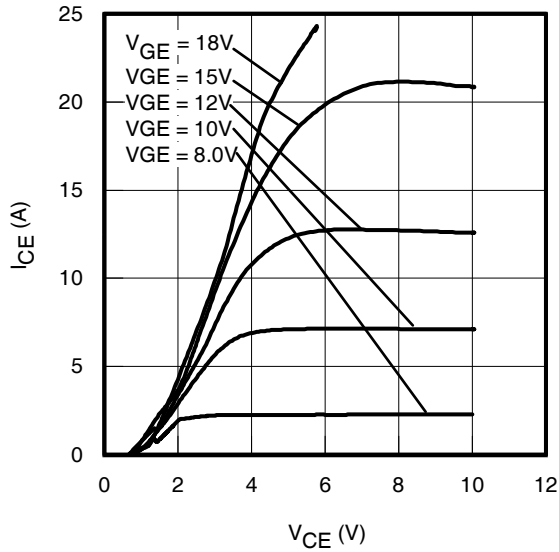


Fig. 5 - Typ. IGBT Output Characteristics
T_j = -40°C; tp = 80μs

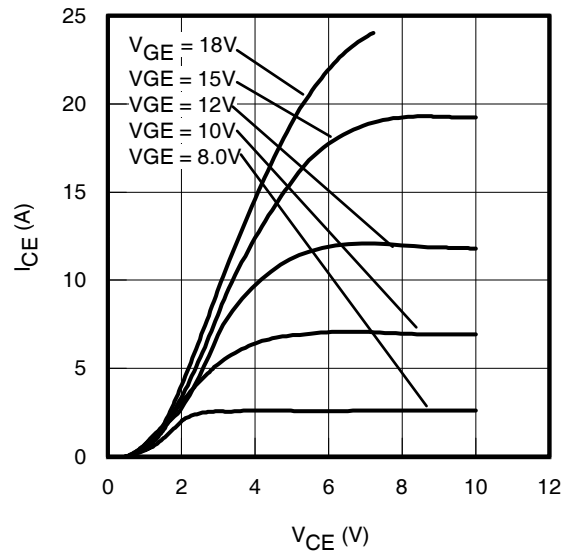


Fig. 6 - Typ. IGBT Output Characteristics
T_j = 25°C; tp = 80μs

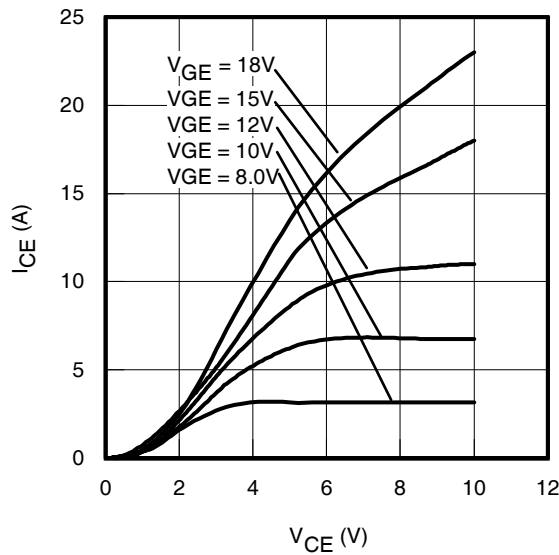


Fig. 7 - Typ. IGBT Output Characteristics
T_j = 150°C; tp = 80μs

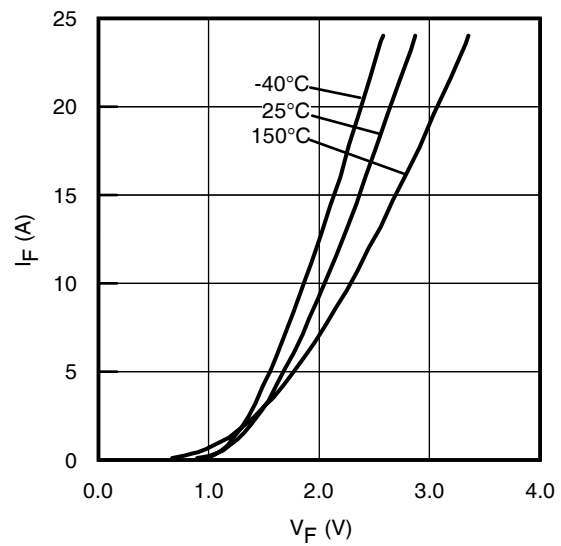


Fig. 8 - Typ. Diode Forward Characteristics
tp = 80μs

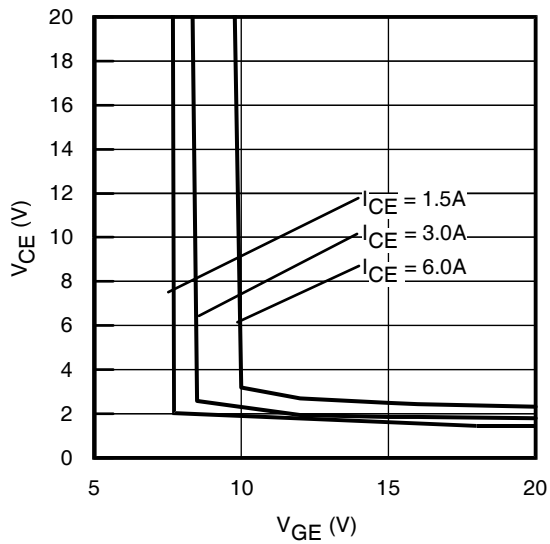


Fig. 9 - Typical V_{CE} vs. V_{GE}
 $T_J = -40^\circ\text{C}$

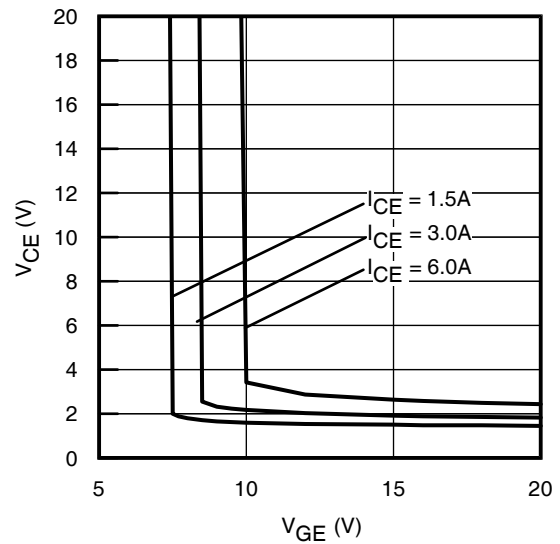


Fig. 10 - Typical V_{CE} vs. V_{GE}
 $T_J = 25^\circ\text{C}$

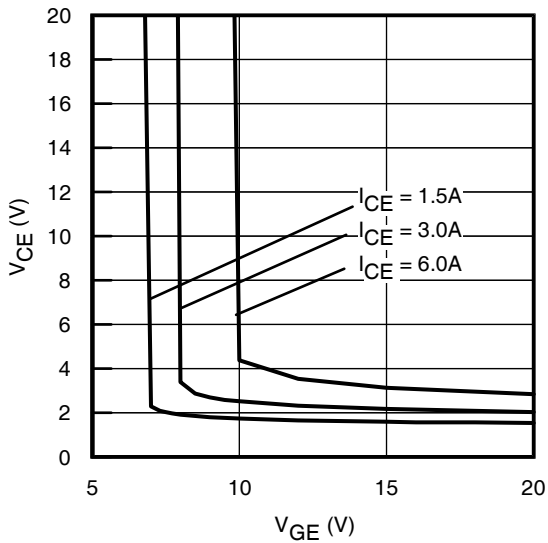


Fig. 11 - Typical V_{CE} vs. V_{GE}
 $T_J = 150^\circ\text{C}$

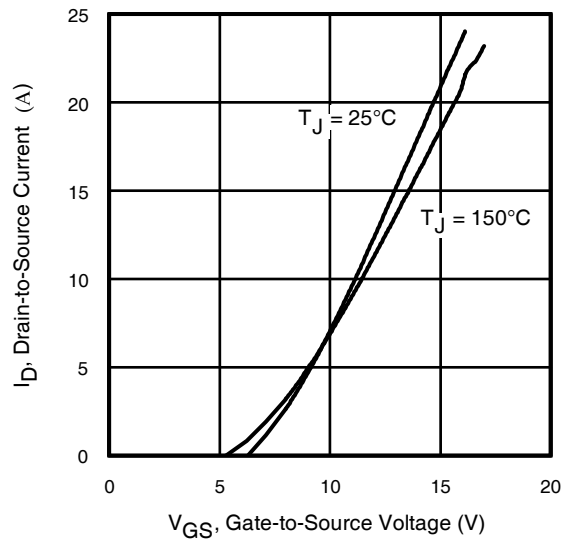


Fig. 12 - Typ. Transfer Characteristics
 $V_{CE} = 50\text{V}$; $t_p = 10\mu\text{s}$

IRGR3B60KD2PbF

International
IR Rectifier

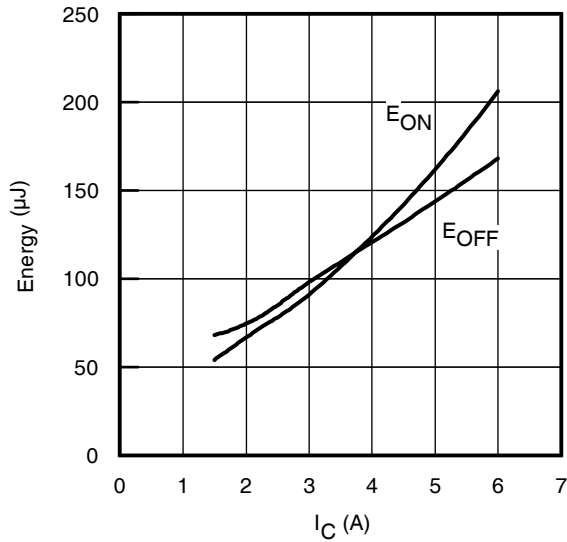


Fig. 13 - Typ. Energy Loss vs. I_C
 $T_J = 150^\circ\text{C}$; $L = 2.5\text{mH}$; $V_{CE} = 400\text{V}$
 $R_G = 100\Omega$; $V_{GE} = 15\text{V}$

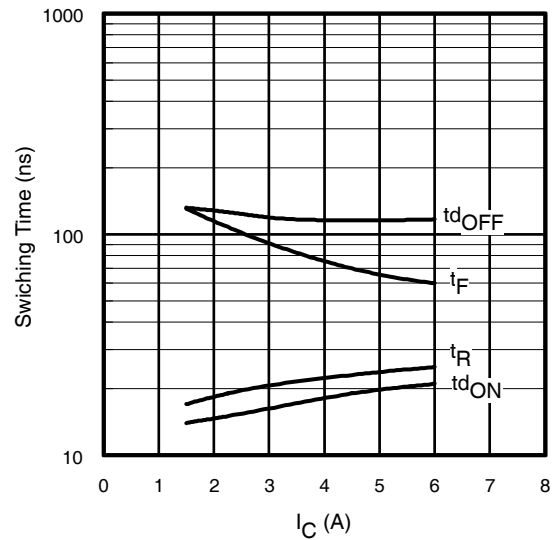


Fig. 14 - Typ. Switching Time vs. I_C
 $T_J = 150^\circ\text{C}$; $L = 2.5\text{mH}$; $V_{CE} = 400\text{V}$
 $R_G = 100\Omega$; $V_{GE} = 15\text{V}$

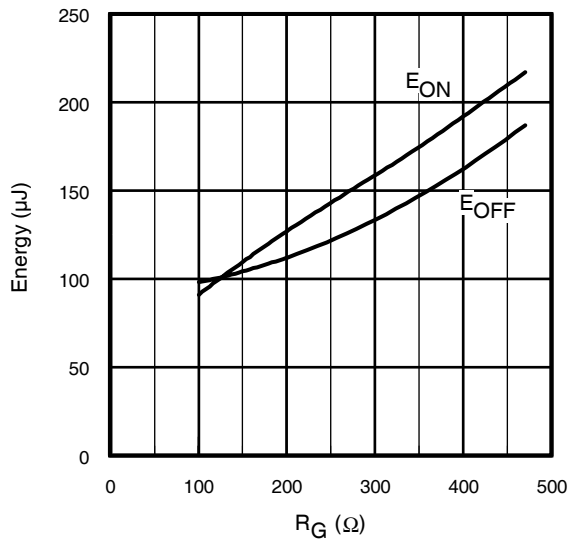


Fig. 15 - Typ. Energy Loss vs. R_G
 $T_J = 150^\circ\text{C}$; $L = 2.5\text{mH}$; $V_{CE} = 400\text{V}$
 $I_{CE} = 3.0\text{A}$; $V_{GE} = 15\text{V}$

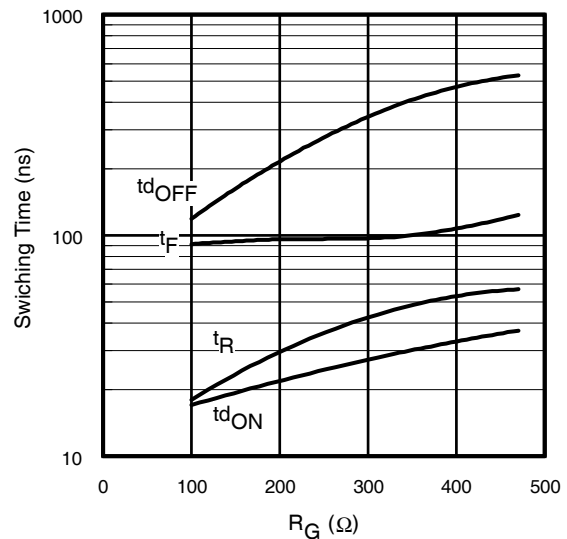


Fig. 16 - Typ. Switching Time vs. R_G
 $T_J = 150^\circ\text{C}$; $L = 2.5\text{mH}$; $V_{CE} = 400\text{V}$
 $I_{CE} = 3.0\text{A}$; $V_{GE} = 15\text{V}$

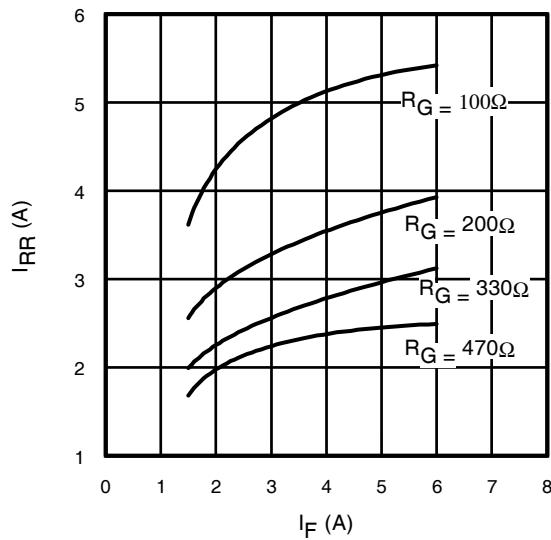


Fig. 17 - Typical Diode I_{RR} vs. I_F
 $T_J = 150^\circ\text{C}$

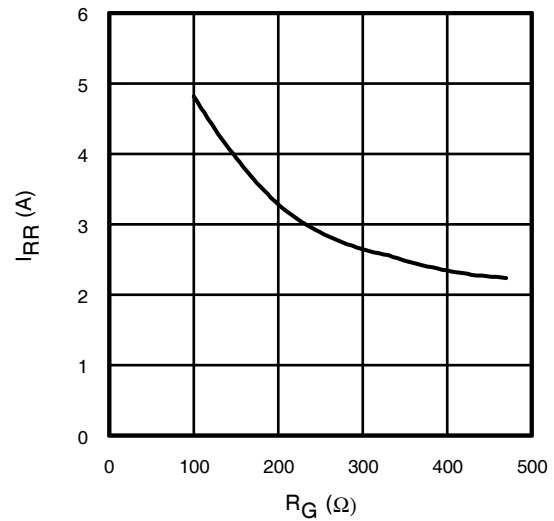


Fig. 18 - Typical Diode I_{RR} vs. R_G
 $T_J = 150^\circ\text{C}$; $I_F = 3.0\text{A}$

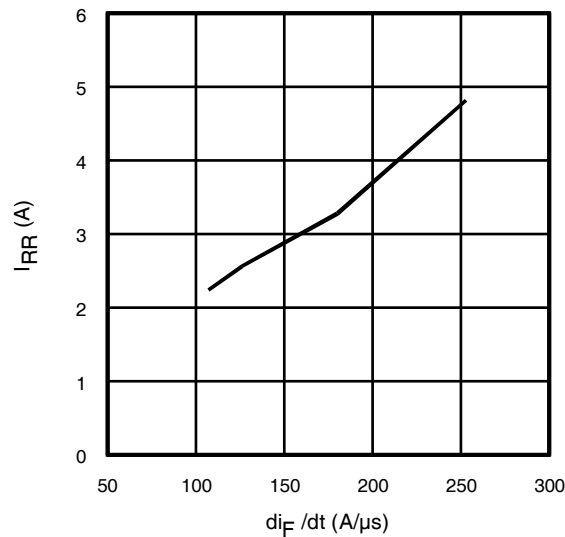


Fig. 19- Typical Diode I_{RR} vs. di_F/dt
 $V_{CC} = 400\text{V}$; $V_{GE} = 15\text{V}$;
 $I_F = 3.0\text{A}$; $T_J = 150^\circ\text{C}$

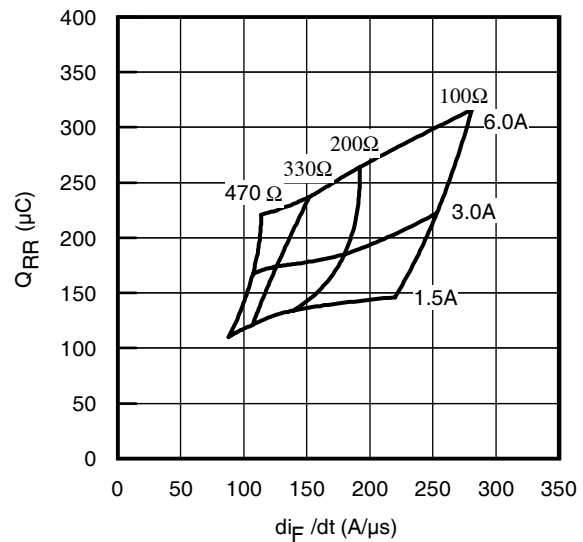


Fig. 20 - Typical Diode Q_{RR}
 $V_{CC} = 400\text{V}$; $V_{GE} = 15\text{V}$; $T_J = 150^\circ\text{C}$

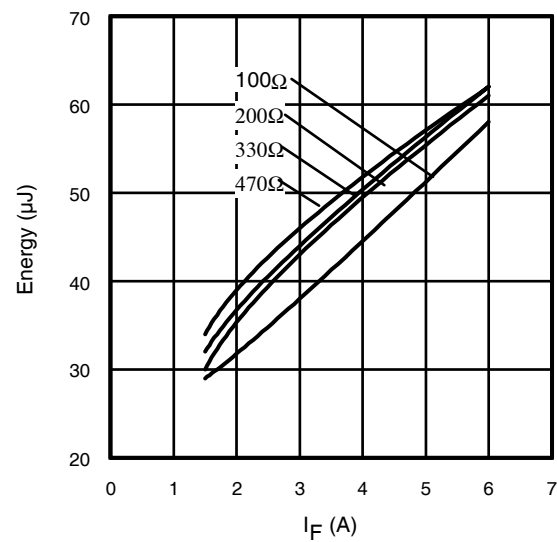


Fig. 21 - Typical Diode E_{RR} vs. I_F
 $T_J = 150^\circ\text{C}$

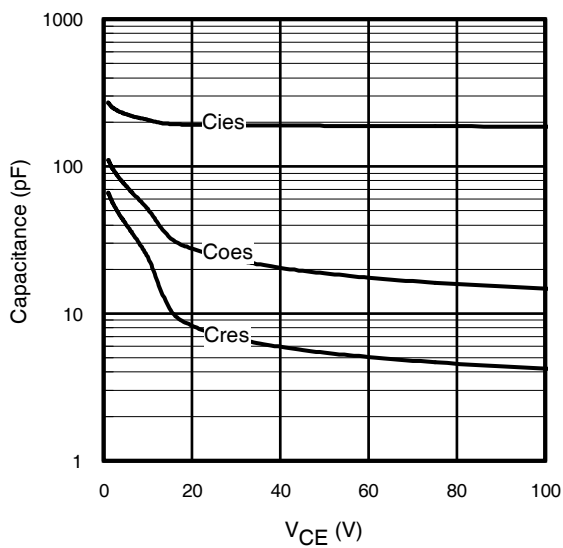


Fig. 22- Typ. Capacitance vs. V_{CE}
 $V_{GE} = 0\text{V}$; $f = 1\text{MHz}$

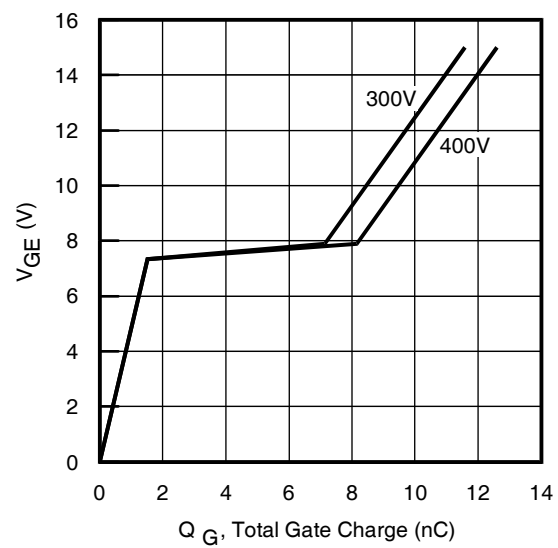


Fig. 23 - Typical Gate Charge vs. V_{GE}
 $I_{CE} = 3.0\text{A}$; $L = 600\mu\text{H}$

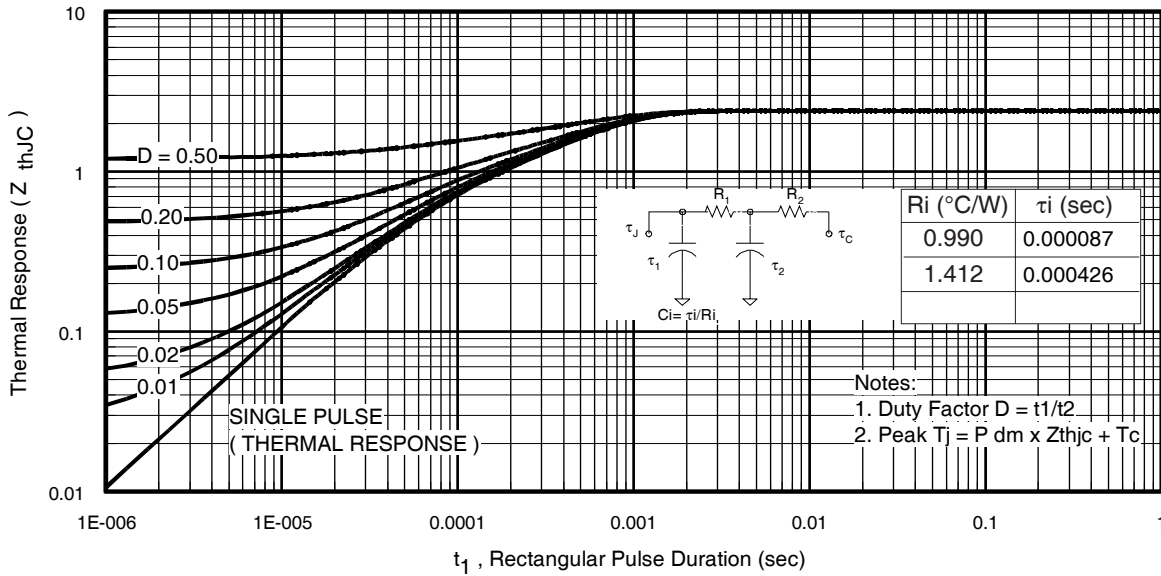


Fig 24. Maximum Transient Thermal Impedance, Junction-to-Case (IGBT)

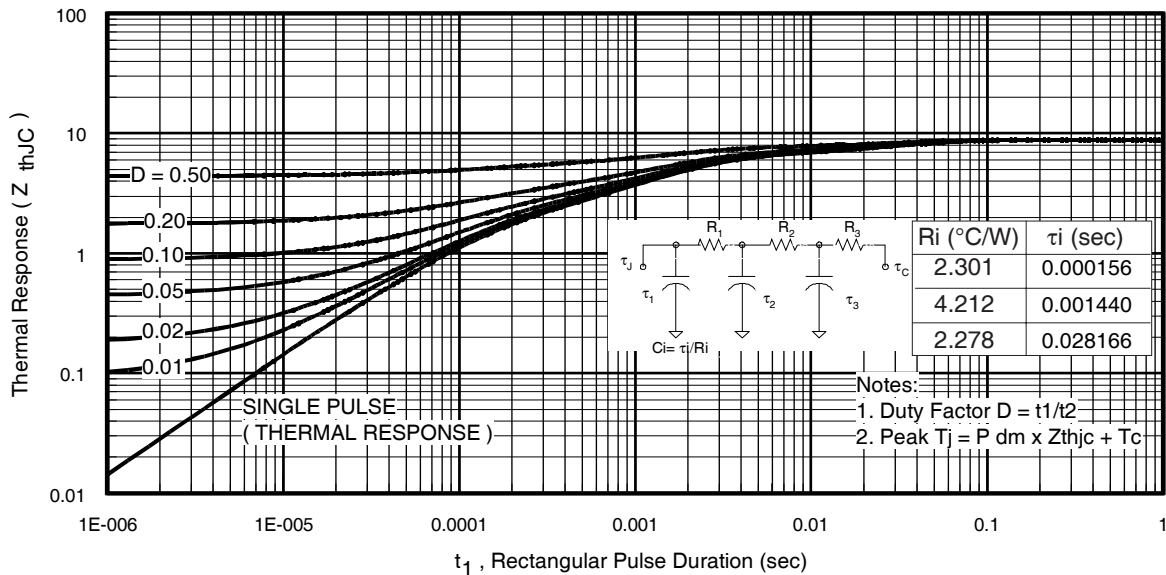


Fig 25. Maximum Transient Thermal Impedance, Junction-to-Case (DIODE)

IRGR3B60KD2PbF

International
IR Rectifier

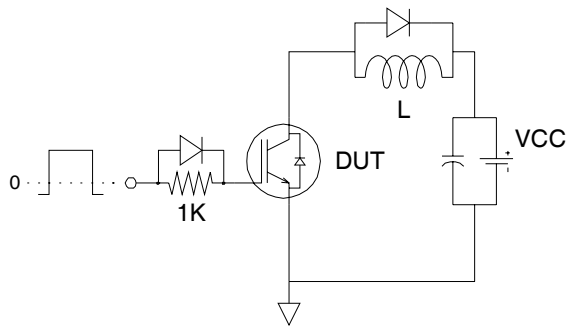


Fig.C.T.1 - Gate Charge Circuit (turn-off)

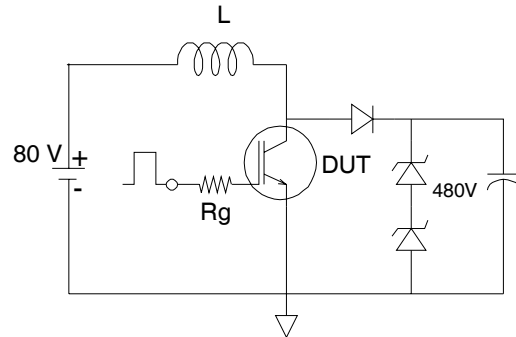


Fig.C.T.2 - RBSOA Circuit

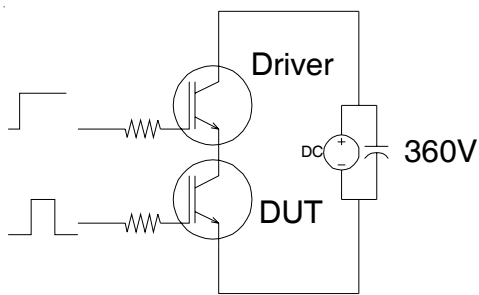


Fig.C.T.3 - S.C.SOA Circuit

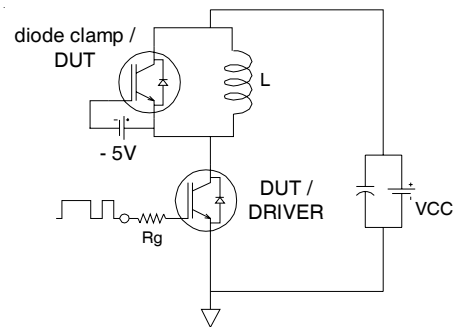


Fig.C.T.4 - Switching Loss Circuit

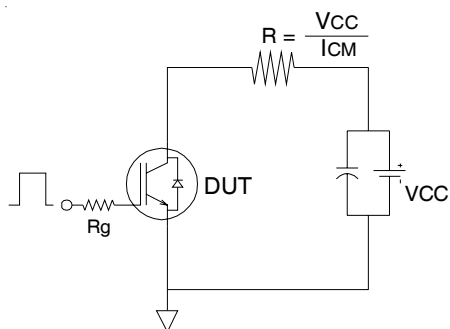


Fig.C.T.5 - Resistive Load Circuit

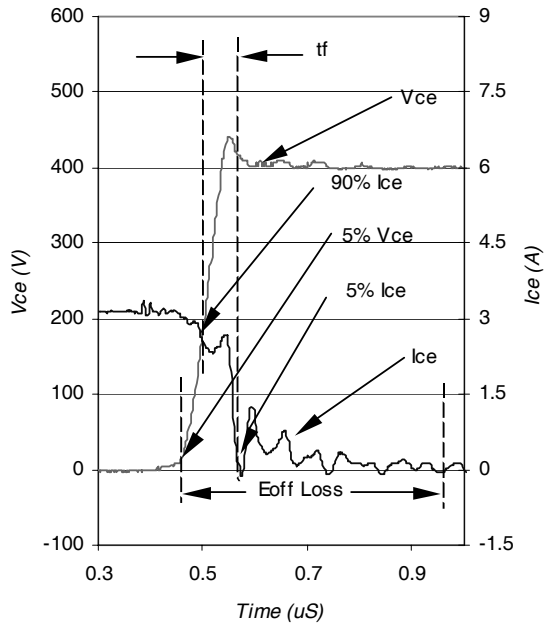


Fig. WF1- Typ. Turn-off Loss Waveform
@ $T_J = 150^\circ\text{C}$ using Fig. CT.4

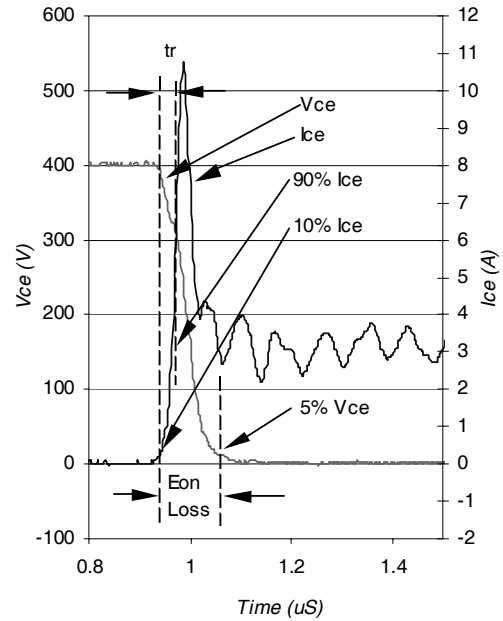


Fig. WF2- Typ. Turn-on Loss Waveform
@ $T_J = 150^\circ\text{C}$ using Fig. CT.4

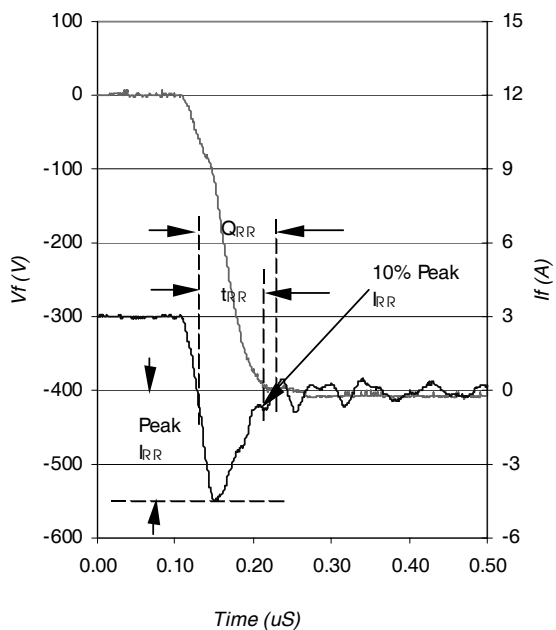


Fig. WF3- Typ. Diode Recovery Waveform
@ $T_J = 150^\circ\text{C}$ using Fig. CT.4

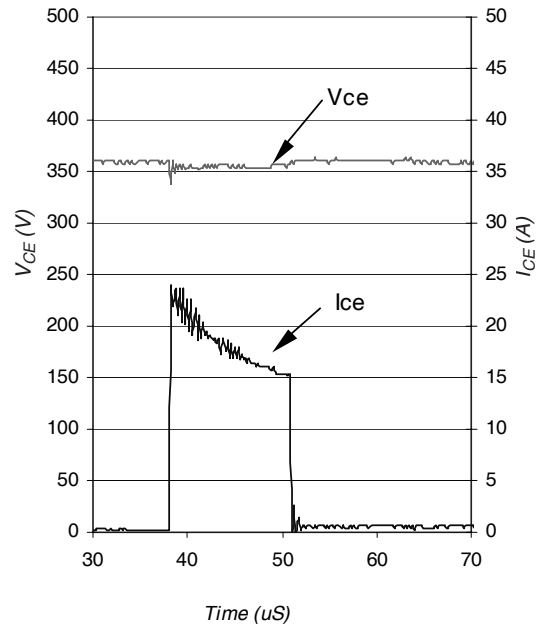


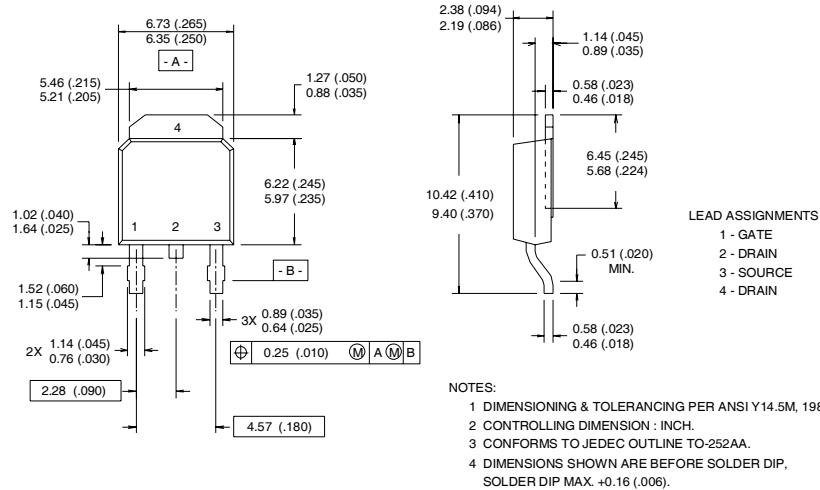
Fig. WF4- Typ. S.C Waveform
@ $T_C = 150^\circ\text{C}$ using Fig. CT.3

IRGR3B60KD2PbF

International
IR Rectifier

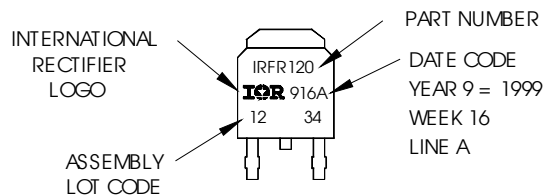
D-Pak (TO-252AA) Package Outline

Dimensions are shown in millimeters (inches)

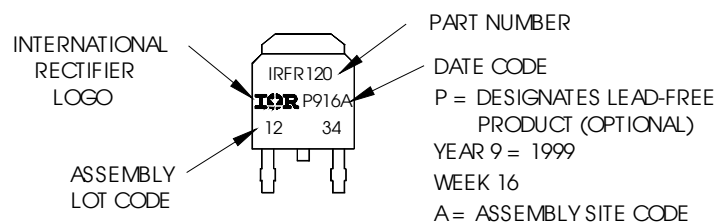


D-Pak (TO-252AA) Part Marking Information (Lead-Free)

EXAMPLE: THIS IS AN IRFR120
WITH ASSEMBLY
LOT CODE 1234
ASSEMBLED ON WW 16, 1999
IN THE ASSEMBLY LINE "A"
Note: "P" in assembly line
position indicates "Lead-Free"

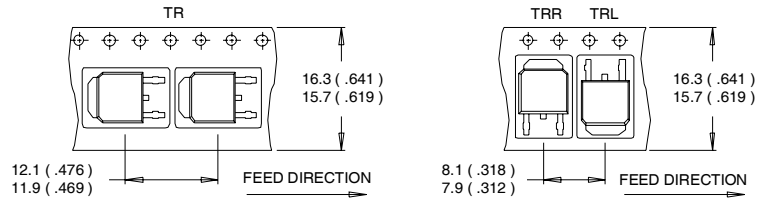


OR



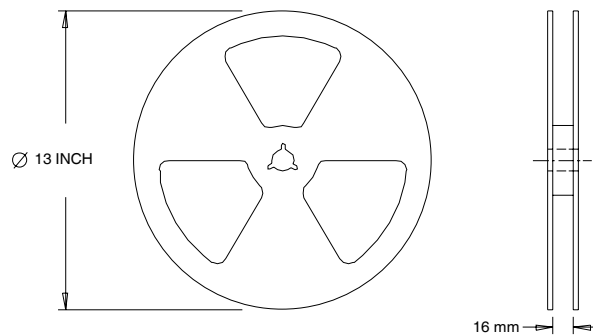
D-Pak (TO-252AA) Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES :

1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :

1. OUTLINE CONFORMS TO EIA-481.

Data and specifications subject to change without notice.
This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web site.

International
IR Rectifier

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105
TAC Fax: (310) 252-7903

Visit us at www.irf.com for sales contact information.02/04

Note: For the most current drawings please refer to the IR website at:
<http://www.irf.com/package/>

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:

[IRGR3B60KD2PBF](#) [IRGR3B60KD2TRLP](#) [IRGR3B60KD2TRP](#) [IRGR3B60KD2TRRP](#)

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Infineon:](#)

[IRGR3B60KD2TRLP](#) [IRGR3B60KD2TRP](#) [IRGR3B60KD2TRRP](#)